ĴΪT
 SEMI CONDUCTOR

150V N-Channel Enhancement Mode MOSFET

Voltage

Current 25 A

Features

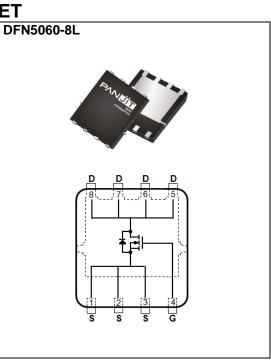
• $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@10A<49m\Omega$

150 V

- Rds(on), Vgs@7V, Id@6A<53m Ω
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case : DFN5060-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.08 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	150		
		V _{GS}	±20	V	
Counting on Durain Country (Note 3)	Tc=25°C		25		
Continuous Drain Current ^(Note 3)	$T_{C}=100^{\circ}C$	l _D	18	А	
Pulsed Drain Current ^(Note 1)	Tc=25°C	I _{DM}	52		
Devuer Dissingtion	Tc=25°C	79			
Power Dissipation	$T_{C}=100^{\circ}C$	Po	40	W	
Continuous Proin Current(Note 4)	T _A =25°C	1	5.1	A	
Continuous Drain Current ^(Note 4)	T _A =70°C	I _D	4.3		
Power Discinction	T _A =25°C	3.3	W		
Power Dissipation	T _A =70°C	Po	2.3	vv	
Single Pulse Avalanche Current ^{(Note}	las	25	А		
Single Pulse Avalanche Energy ^(Note 5)		Eas	55	mJ	
Operating Junction and Storage Temperature Range		TJ,TSTG	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	1.9	°C/W	
	Junction to Ambient	R _{0JA}	45		



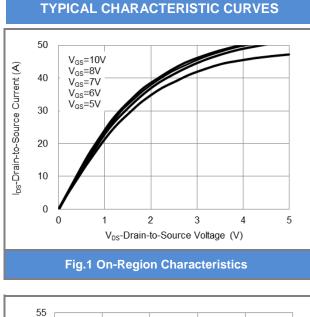
Electrical Characteristics (TA=25°C unless otherwise noted)

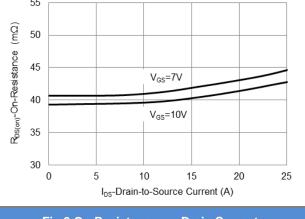
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static		•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	150	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2	3	4	
Durin Country On Chata Davistance		V_{GS} =10V, I_{D} =10A	-	39	49	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =7V, I _D =6A	-	41	41 53 mΩ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =150V, V_{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Dynamic ^(Note 6)						
Total Gate Charge	Qg		-	22	29	
Gate-Source Charge	Qgs	$V_{DS}=75V, I_{D}=10A,$	-	7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6	-	
Input Capacitance	Ciss	V _{DS} =75V, V _{GS} =0V,	-	1116	1450	pF
Output Capacitance	Coss		-	81	142	
Reverse Transfer Capacitance	Crss	f=1MHz	-	23	-	
Gate resistance	Rg	f=1MHz	-	0.8	-	Ω
Turn-On Delay Time	td(on)		-	8.4	-	
Turn-On Rise Time	tr	V _{DS} =75V, I _D =10A,	-	14	-	
Turn-Off Delay Time	td(off)	$V_{GS}=10V, R_G=3\Omega$	-	17	-	ns
Turn-Off Fall Time	tf		-	11	-	
Drain-Source Diode	-			_	-	
Diode Forward Current	Is	T _c =25°C	-	-	25	
Pulsed Diode Forward Current	I _{SM}	1c=25 C	-	-	52	A
Diode Forward Voltage	V _{SD}	Is=20A, V _{GS} =0V	-	0.9	1.3	V
Reverse Recovery Time	Trr	V _{DD} =75V,V _{GS} =0V	-	58	-	ns
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	90	-	nC

NOTES :

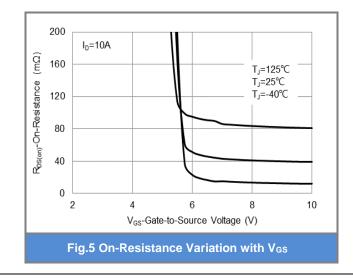
- 1. Pulse width \leq 100us, Duty cycle \leq 2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an $R_{\theta JC}$ = 1.9°C/W.
- 4. $R_{\theta,JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. E_{AS} is calculated based on the condition of L=1mH, I_{AS}=10.5A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.1mH, I_{AS}=25A in production.
- 6. Guaranteed by design, not subject to production testing.











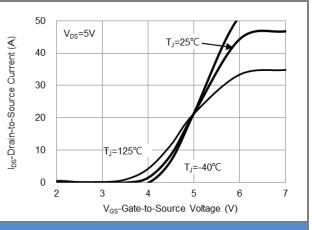


Fig.2 Transfer Characteristics

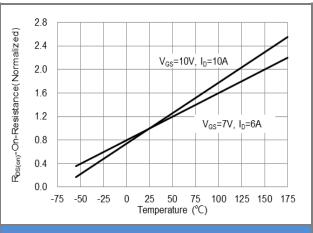
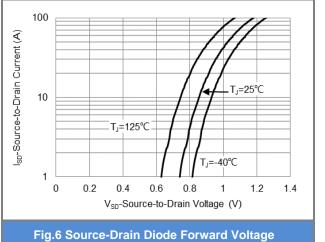
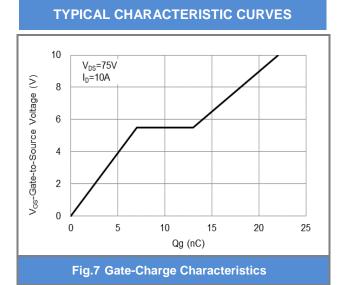
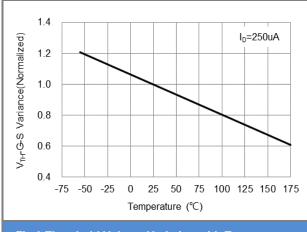


Fig.4 On-Resistance vs. Junction temperature

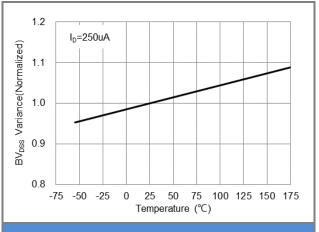














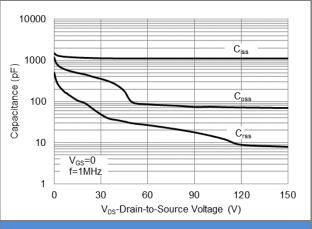
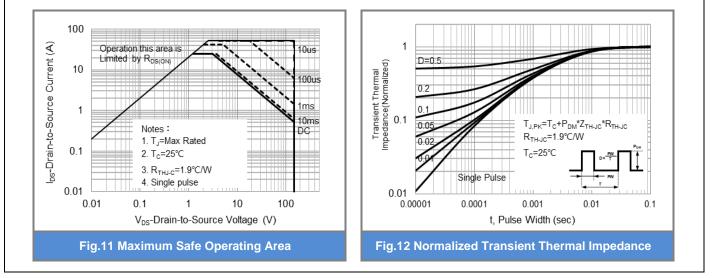


Fig.10 Capacitance vs. Drain-Source Voltage

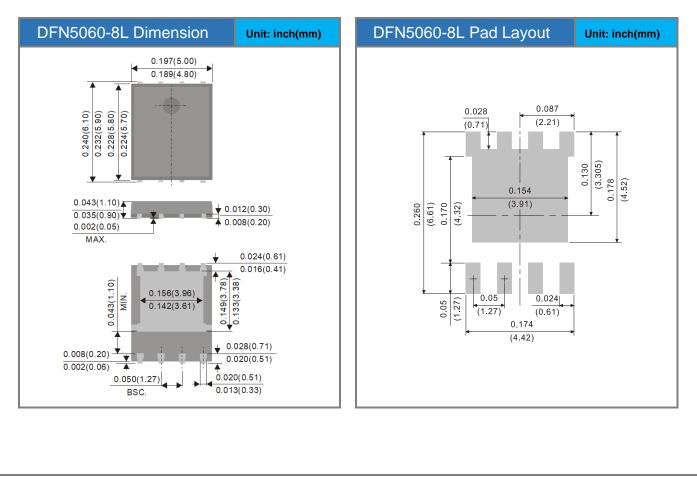




Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PJQ5594-AU	DFN5060-8L	3K pcs / 13" reel	Q5594	

Packaging Information & Mounting Pad Layout





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